## SK 35 NT



### Thyristor Module

#### SK 35 NT

Preliminary Data

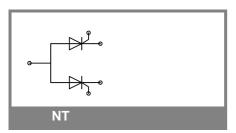
### Features

- Compact design
- One screw mounting
- Heat transfer and isolation through direct copper bonded aluminium oxide (DCB)
- Glass passivated thyristor chips
- Up to 1600V reverse voltage
- High surge currents
- UL recognized, file no. E 63 532

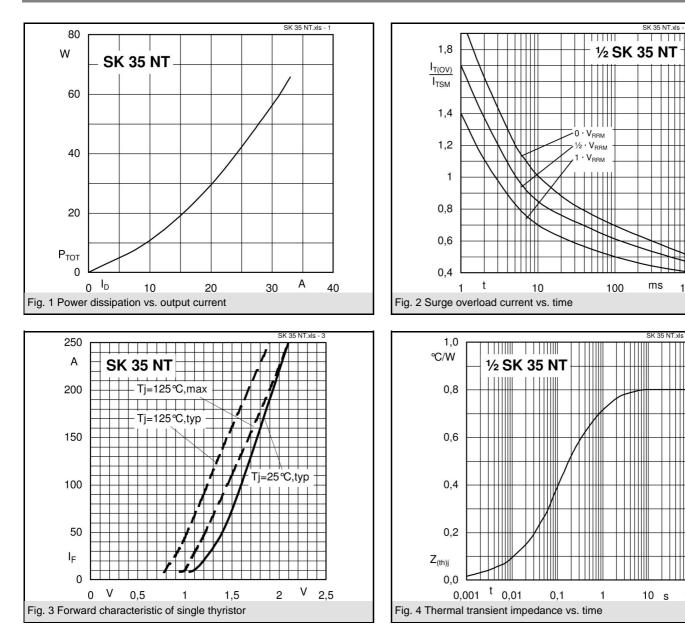
### **Typical Applications**

- Soft starters
- Light control (studios, theaters)
- Temperature control

V <sub>RSM</sub>	1	V <sub>RRM</sub> , V <sub>DRM</sub>	I <sub>RM</sub>	<sub>S</sub> = (T <sub>h</sub> = 80°C) A (full conduction	on)
V V		V	(T <sub>h</sub> = 85 °C)		
900		800		SK 35 NT 08	
1300	)	1200		SK 35 NT 12	
1700	)	1600		SK 35 NT 16	
Symbol	Con	ditions		Values	Unit
I <sub>RMS</sub>	<i>'</i>	180° ;			A
		180° ;			A
I <sub>TAV</sub>	sin. 1	80°; T <sub>h</sub> = 100°C		23	A
I <sub>TAV</sub>	sin. 1	80°; T <sub>h</sub> = 85°C		33	A
I <sub>TSM</sub>	T <sub>vi</sub> =	25 °C ; 10 ms		1000	A
	$T_{vi} =$	125 °C ; 10 ms		900	A
i²t	$T_{vi} =$	25 °C ; 8,3 10 ms		5000	A²s
	T <sub>vi</sub> =	125 °C ; 8,3 10 ms		4000	A²s
V <sub>T</sub>	,	25 °C, I <sub>T</sub> = 120 A		max. 1,8	V
V <sub>T(TO)</sub>		125 °C		max. 1	V
r <sub>T</sub>		125 °C		max. 6	mΩ
I <sub>DD</sub> ;I <sub>RD</sub>		25 °C, V <sub>RD</sub> =V <sub>RRM</sub>		max. 0,5	mA
	,	125 °C, V <sub>RD</sub> =V <sub>RRM</sub>		max. 15	mA
t <sub>gd</sub>				1	μs
t <sub>gr</sub>	V <sub>D</sub> =	0,67 *V <sub>DRM</sub>		2	μs
(dv/dt) <sub>cr</sub>	T <sub>vi</sub> =	125 °C		1000	V/µs
(di/dt) <sub>cr</sub>	$T_{vi} =$	125 °C; f= 50 60 H	z	50	A/µs
t <sub>q</sub>	T <sub>vi</sub> =	125 °C; typ.		80	μs
I <sub>H</sub>	$T_{vj} =$	25 °C; typ. / max.		100 / 200	mA
I <sub>L</sub>	$T_{vj}$ = 25 °C; $R_G$ = 33 $\Omega$ ; typ. / max.		o. / max.	200 / 400	mA
V <sub>GT</sub>		25 °C; d.c.		min. 2	V
I <sub>GT</sub>		25 °C; d.c.		min. 100	mA
V <sub>GD</sub>	T <sub>vj</sub> =	125 °C; d.c.		max. 0,25	V
$I_{GD}$	T <sub>vj</sub> =	125 °C; d.c.		max. 5	mA
R <sub>th(j-h)</sub>		per thyristor		0,8	K/W
0,	cont.	per module		0,4	K/W
R <sub>th(j-h)</sub>		80°, per thyristor		0,84	K/W
	sin 1	80° per module		0,42	K/W
T <sub>vj</sub>				-40 +125	°C
T <sub>stg</sub>				-40 +125	°C
T <sub>solder</sub>		nals, 10s		260	°C
V <sub>isol</sub>	a. c.	50 Hz; r.m.s.; 1 s / 1 r	nin.	3000 / 2500	V~
M <sub>s</sub>					Nm
M <sub>t</sub>	mour	nting torque		1,5	Nm
а					m/s²
m				13	g
Case	ase SEMITOP®1			Т9	



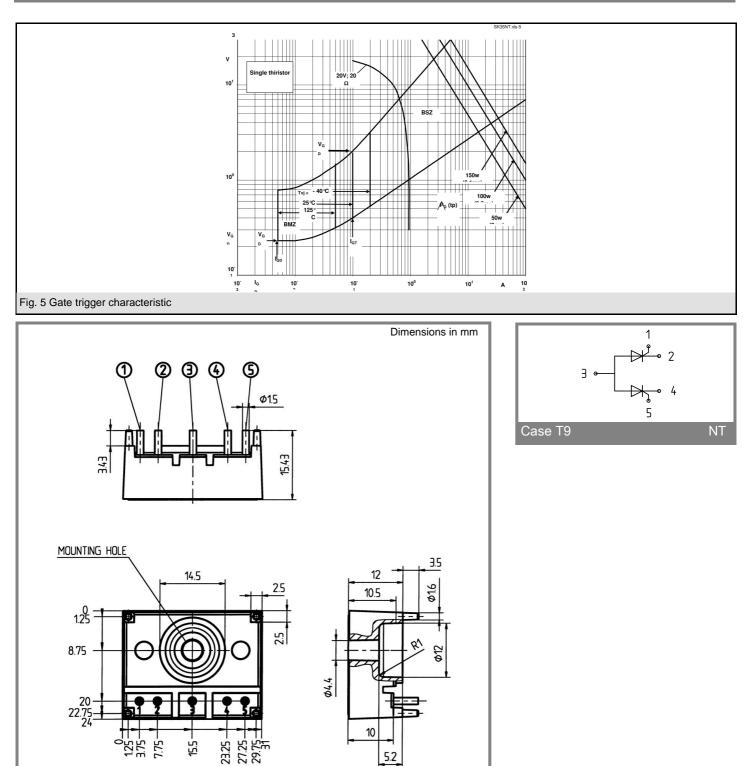
### SK 35 NT



1000

100

# SK 35 NT



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Case T9